

06-16-1999

COVER SHEET

U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office



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101066898

To the Honorable Commissioner of Patents and Trademarks, U.S. Department of Commerce  
and the attached original documents or copy thereof

1. Name of Conveying Part(ies):

Li Li  
Yongjun Jeff Hu

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: Micron Technology, Inc.

Internal Address:

Street Address: 8000 South Federal Way

City: Boise State: ID Zip: 83706

Additional names(s) & address(es) attached: ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Security Agreement  
☐ Merger ☐ Change of Name  
☐ Other

Execution Date: May 27, 1999

4. Application number(s) or patent number(s):

09/323 749  
If this document is being filed together with a new application, the execution date of the application is: May 27, 1999

A. Patent Application No.(s):

B. Patent No.(s)

Additional numbers attached: ☐ Yes ☒ No

Additional numbers attached: ☐ Yes ☒ No

Name and address of party to whom correspondence concerning document should be mailed:

Name: Mark S. Matkin

Internal Address: Wells, St. John, Roberts,

Gregory & Matkin P.S.

Street Address: 601 W. First Avenue, Ste. 1300

City: Spokane State: WA Zip: 99201-3828

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$ 40.00  
☒ Enclosed  
☐ Authorized to be charged to deposit account

8. Deposit account number  
23-0925

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and Signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Mark S. Matkin

Name of Person Signing

Signature

Date

TOTAL NUMBER OF PAGES INCLUDING COVER SHEET, ATTACHMENTS AND DOCUMENT: 5

OMB No. 0651-0011 (exp. 9/94)

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**ASSIGNMENT****PARTIES TO THE ASSIGNMENT:****INVENTORS:**

Li Li

Yongjun Jeff Hu

**ASSIGNEE:**

Micron Technology, Inc.  
Corporation of the State of Delaware  
8000 South Federal Way  
Boise, Idaho 83706-9632

**BACKGROUND OF THIS ASSIGNMENT:**

INVENTORS have conceived certain new and useful inventions disclosed in a United States patent application titled "Method Of Forming A Conductive Line And Method Of Forming A Local Interconnect".

MICRON TECHNOLOGY, INC. (hereinafter referred to as "ASSIGNEE") desires to acquire the entire right, title and interest in said inventions and with respect to any Letters Patent that may be granted with respect to the inventions in both the United States and in all foreign countries.

**THE PARTIES AGREE AS FOLLOWS:**

In consideration of good and valuable consideration, the receipt sufficiency and adequacy of which is hereby acknowledged, INVENTORS hereby sell, assign and transfer to ASSIGNEE the entire right, title and interest in the above-identified application executed currently with this

1 assignment and to any reissues, renewals, divisions or continuations  
2 thereof, and hereby authorizes the Commissioner of Patents and  
3 Trademarks to issue such Letters Patent to ASSIGNEE for the sole use  
4 of ASSIGNEE, its successors or assigns.

5 INVENTORS further agree to execute, at the request and expense  
6 of ASSIGNEE such other formal documents as may be required to fully  
7 convey the interest transferred herein and will similarly execute any  
8 application papers required for the filing of any division, continuation,  
9 renewal or reissue of the patent application or resulting Letters Patent;  
10 and will generally do everything necessary or desirable to obtain and  
11 enforce proper protection for the inventions assigned hereby.

12 INVENTORS further assign to ASSIGNEE the whole right, title  
13 and interest in the inventions disclosed in the application throughout all  
14 countries foreign to the United States. ASSIGNEE is hereby authorized  
15 to apply for patents relating to the inventions in its own name in  
16 countries where such procedure is proper; to claim the benefit of the  
17 International Convention; to file and prosecute International Applications  
18 relating to the inventions under the Patent Cooperation Treaty; and to  
19 file and prosecute applications relating to the inventions under the  
20 European Patent Convention. INVENTORS agree to execute applications  
21 relating to the inventions in those countries and under those conventions  
22 where it is necessary that the same be executed by the inventor, and  
23 to execute assignments of such applications and the resulting Letters  
24

Patent to ASSIGNEE as well as all other necessary papers in relation to such applications and Letters Patent.

INVENTORS further warrant and covenant that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full rights to convey the same as herein expressed is possessed by the undersigned.

To be binding on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignees.

(Signature)

Li Li  
Li Li

Date: 5/27/99

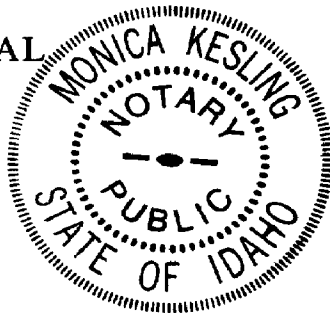
State of Idaho

) ss.

County of Ada

BEFORE ME, this 27th day of May 1999 personally appeared the above-named inventor, to me known to be the person who is described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her own free will for the purpose therein expressed.

SEAL



Monica Kesling  
Notary or Consular Officer

My Commission Expires: 5-17-2005

1 (Signature)

Yongjun Jeff Hu

Date: 05/27/99

2  
3 State of

Idaho

) ss.

4 County of

Ada

5 BEFORE ME, this

27

day of

May

1999

6 personally appeared the above-named inventor, to me known to be the  
7 person who is described in and who executed the foregoing assignment  
instrument and acknowledged to me that he/she executed the same of  
his/her own free will for the purpose therein expressed.



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Notary or Consular Officer

My Commission Expires:

5-17-2005